SiZ342DT

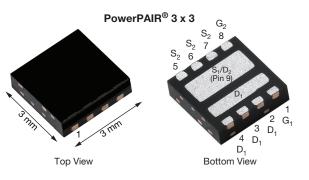
RoHS

COMPLIANT HALOGEN



### Dual N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY					
	V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) MAX.	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)	
Channel-1		0.0115 at V <sub>GS</sub> = 10 V	30 <sup>a</sup>		
and Channel-2	30	0.0153 at $V_{GS}$ = 4.5 V	27.5	4.5 nC	



#### **Ordering Information:**

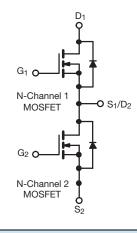
SiZ342DT-T1-GE3 (lead (Pb)-free and halogen-free)

#### **FEATURES**

- PowerPAIR<sup>®</sup> optimizes high-side and low-side MOSFETs for synchronous buck converters
- TrenchFET<sup>®</sup> Gen IV power MOSFETs
- 100 % R<sub>q</sub> and UIS tested
- FREE · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### APPLICATIONS

- Synchronous buck
  - Battery charging
  - Computer system power
  - Graphic cards
- POL



PARAMETER		CHANNEL-1 AND CHANNEL-2				
		SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V <sub>DS</sub>	30	v		
Gate-Source Voltage		V <sub>GS</sub>	+20 / -16	v		
	T <sub>C</sub> = 25 °C		30 <sup>a</sup>			
Continuous Drain Current (T. 150 °C)	T <sub>C</sub> = 70 °C		26.5	1		
Continuous Drain Current ( $T_J = 150 \ ^\circ C$ )	T <sub>A</sub> = 25 °C	I <sub>D</sub>	15.6 <sup>b, c</sup>			
	T <sub>A</sub> = 70 °C		12.4 <sup>b, c</sup>			
Pulsed Drain Current (t = 100 µs)		I <sub>DM</sub> 100	100	— A		
Cartinuaria Carria Diada Comant	T <sub>C</sub> = 25 °C		13.9			
Continuous Source Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	3.1 <sup>b, c</sup>			
Avalanche Current		I <sub>AS</sub>	10			
Single Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	5	mJ		
	T <sub>C</sub> = 25 °C		16.7			
Mauinum Davies Diasis atian	T <sub>C</sub> = 70 °C		10.7			
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.7 <sup>b, c</sup>	- W		
	T <sub>A</sub> = 70 °C		2.4 <sup>b, c</sup>	1		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 150	**		
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>			260			

#### Notes

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.

- d. See solder profile (www.vishay.com/doc?73257). The PowerPAIR 3 x 3 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

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c. t = 10 s.



#### THERMAL RESISTANCE RATINGS

PARAMETER		CHANNEL-1 AND CHANNEL-2				
		SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient a, b	t ≤ 10 s	R <sub>thJA</sub>	27	34	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	6	7.5	0/11	

Notes

a. Surface mounted on 1" x 1" FR4 board.

b. Maximum under steady state conditions is 69 °C/W.

SPECIFICATIONS (T <sub>J</sub> = 25 °C	, unless othe	rwise noted)						
DADAMETED	CHANNEL-1 AND CHANNEL-2							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT		
Static	•					•		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	30	-	-	V		
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA	-	20	-	m)//°C		
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-5.6	-	mV/°C		
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.2	-	2.4	V		
Gate Source Leakage	I <sub>GSS</sub>	$V_{DS}$ =0 V, $V_{GS}$ = +20 V/ -16 V	-	-	± 100	nA		
Zana Oata Malta na Duain Ouwant		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1			
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	5	μA		
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	$V_{DS} \le 5 \text{ V}, V_{GS} = 10 \text{ V}$	10	-	-	А		
Drain-Source On-State Resistance <sup>b</sup>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 14.4 A	-	0.0084	0.0115	0		
Drain-Source On-State Resistance <sup>5</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 13 \text{ A}$	-	0.0111	0.0153	Ω		
Forward Transconductance b	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 14.4 A	-	37	-	S		
Dynamic <sup>a</sup>	•					•		
Input Capacitance	C <sub>iss</sub>		-	650	-			
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ = 15 V, $V_{GS}$ = 0 V, f = 1 MHz	-	236	-	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>		-	20	-			
C <sub>rss</sub> / C <sub>iss</sub> Ratio			0.03	-	0.06	-		
Tatal Oata Ohanna	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 14.4 \text{ A}$	-	10	20	-		
Total Gate Charge			-	4.5	9			
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = 15 V,V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 14.4 A	-	2.1	-	nC		
Gate-Drain Charge	Q <sub>gd</sub>	$v_{DS} = 15 v, v_{GS} = 4.5 v, I_D = 14.4 A$	-	0.7	-	1		
Output Charge	Q <sub>oss</sub>		-	6.6	-			
Gate Resistance	Rg	f = 1 MHz	0.3	1.4	2.8	Ω		
Turn-On Delay Time	t <sub>d(on)</sub>		-	15	23			
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$	-	50	75	1		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A},  V_{\text{GEN}} = 4.5  \text{V},  \text{R}_\text{g} = 1  \Omega$	-	16	24	1		
Fall Time	t <sub>f</sub>		-	10	20			
Turn-On Delay Time	t <sub>d(on)</sub>		-	8	16	ns		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$	-	15	23			
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ 10 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$	-	17	26	1		
Fall Time	t <sub>f</sub>		-	7	14	1		



## SiZ342DT

## Vishay Siliconix

### **SPECIFICATIONS** (T<sub>1</sub> = 25 °C, unless otherwise noted)

PABAMETER	CHANNEL-1 AND CHANNEL-2							
PARAMETER	SYMBOL TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT		
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	13.9	А		
Pulse Diode Forward Current (t = 100 µs)	I <sub>SM</sub>		-	-	100	~		
Body Diode Voltage	$V_{SD}$	$I_{S} = 10 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.8	1.2	V		
Body Diode Reverse Recovery Time	t <sub>rr</sub>		-	20	35	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 10 A, dl/dt = 100 A/μs, Τ <sub>.1</sub> = 25 °C	-	10	20	nC		
Reverse Recovery Fall Time	ta	$r_F = 10 \text{ A}, \text{ u/ut} = 100 \text{ A/} \mu\text{s}, \text{ 1}\text{J} = 23 \text{ C}$	-	12.5	-	20		
Reverse Recovery Rise Time	t <sub>b</sub>		-	7.5	-	ns		

#### Notes

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

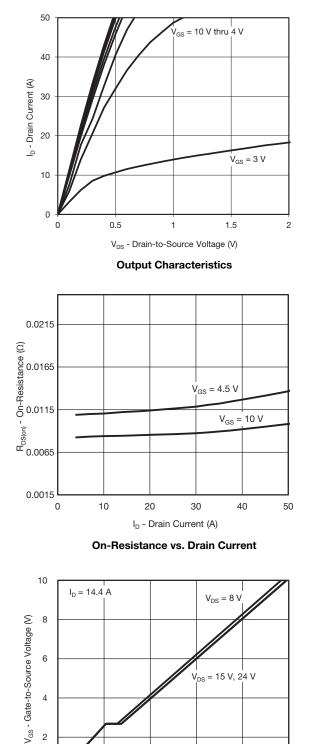
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

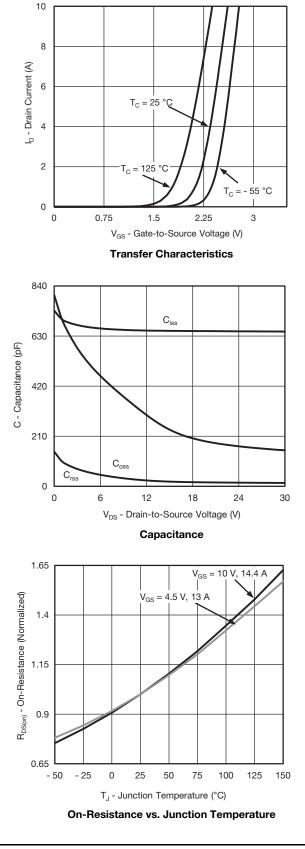
SiZ342DT



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### CHANNEL-1 AND CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





S15-0031-Rev. B, 19-Jan-15

2

4

6

Q<sub>q</sub> - Total Gate Charge (nC)

**Gate Charge** 

8

10

4

2

0 0

4

Document Number: 62949

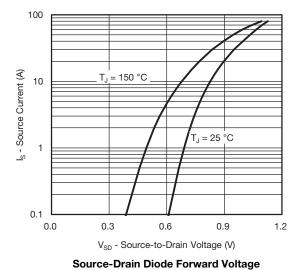
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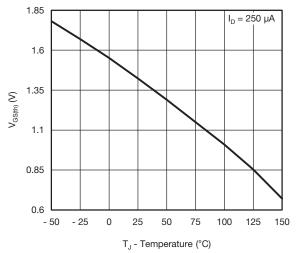
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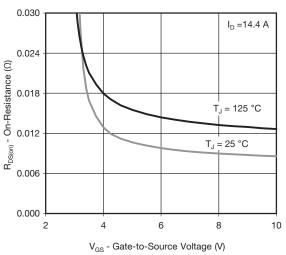
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### CHANNEL-1 AND CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

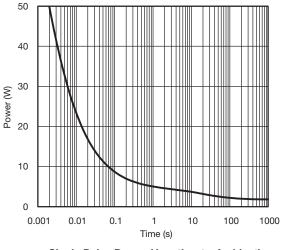




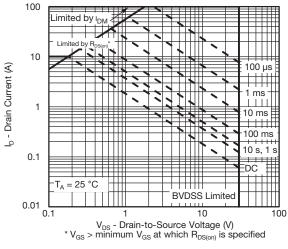
**Threshold Voltage** 



**On-Resistance vs. Gate-to-Source Voltage** 



Single Pulse Power (Junction-to-Ambient)



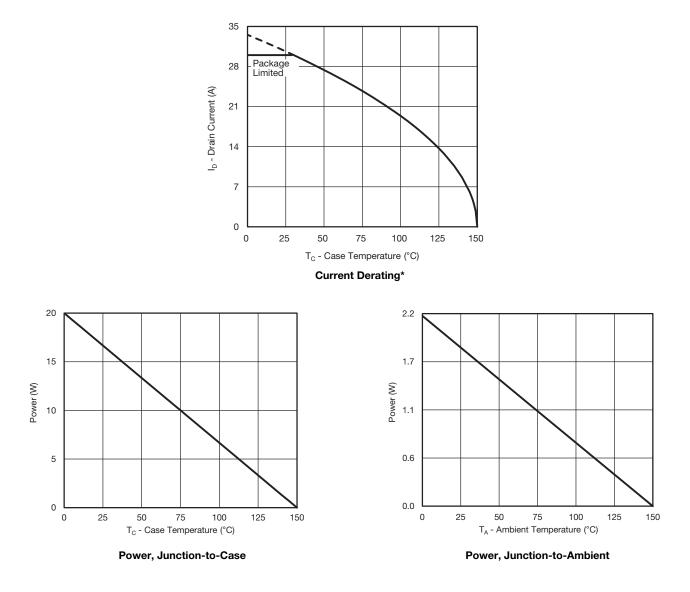
Safe Operating Area, Junction-to-Ambient

5

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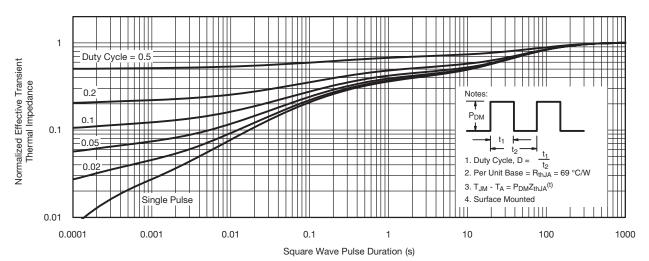
#### CHANNEL-1 AND CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



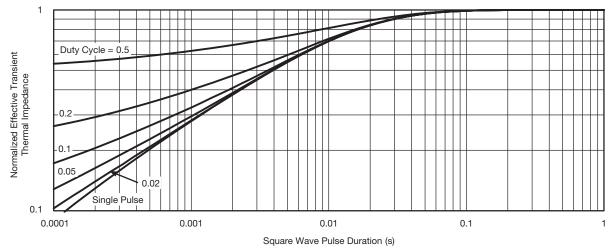
\* The power dissipation  $P_D$  is based on  $T_{J (max.)} = 150 \text{ °C}$ , using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.







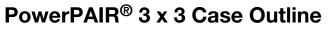
Normalized Thermal Transient Impedance, Junction-to-Ambient

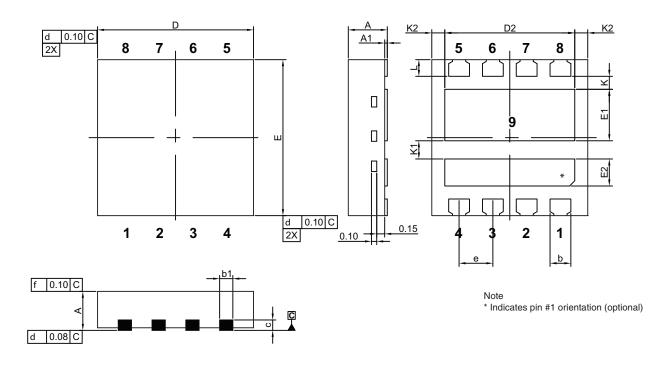


Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?62949</u>.







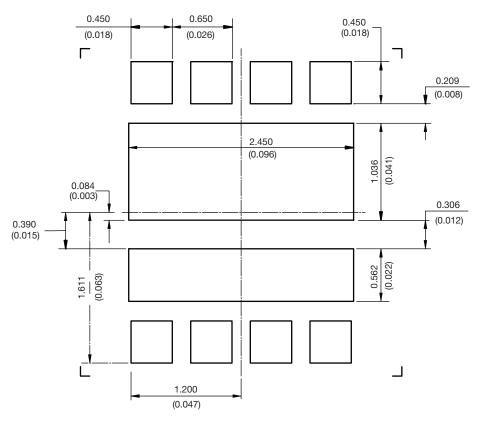
		MILLIMETERS		INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.70	0.75	0.80	0.028	0.030	0.031	
A1	0.00		0.05	0.000		0.002	
b	0.35	0.40	0.45	0.014	0.016	0.018	
b1	0.20	0.25	0.38	0.008	0.010	0.015	
С	0.18	0.20	0.23	0.007	0.008	0.009	
D	2.90	3.00	3.10	0.114	0.118	0.122	
D2	2.35	2.40	2.45	0.093	0.094	0.096	
E	2.90	3.00	3.10	0.114	0.118	0.122	
E1	0.94	0.99	1.04	0.037	0.039	0.041	
E2	0.47	0.52	0.57	0.019	0.020	0.022	
е		0.65 BSC		0.026 BSC			
К		0.25 typ.			0.010 typ.		
K1		0.35 typ.			0.014 typ.		
K2	0.30 typ.			0.012 typ.			
L	0.27	0.32	0.37	0.011	0.013	0.015	



PAD Pattern

Vishay Siliconix

#### **RECOMMENDED MINIMUM PAD FOR PowerPAIR® 3 x 3**



Recommended PAD for PowerPAIR 3 x 3 Dimensions in millimeters (inches) Keep-Out 3.5 mm x 3.5 mm for non terminating traces



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